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Attorney Docket No. 300.1138

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re Patent Application of:

Mitsutoshi HIGASHI

Application No.: 10/706,912 Group Art Unit: 2813

Filed: November 14, 2003 Examiner: SCHILLINGER, LAURA M

For: ELECTRONIC DEVICES AND ITS PRODUCTION METHODS

## **INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

Sir:

1.

OCT 18 2005

In accordance with the duty of disclosure provisions of 37 CFR § 1.56, there is hereby provided certain information which the Examiner may consider material to the examination of the subject U.S. patent application. It is requested that the Examiner make this information of record if it is deemed material to the examination of the subject application.

Enclosures accompanying this Information Disclosure Statement are:

		1a. 🛚	Form PTO-1449.
		1b. 🔯	Copy(ies) of IDS citation(s), except for U.S. Patents and U.S. Patent Application publications.
		1c. 🛚	English language copy of a communication(s) from a foreign Patent Office or a PCT International Search Report.
		1d. 🗌	English language translation (complete, Abstract or relevant portion(s)) attached to non-English language publications as indicated on the attached Form PTO-1449.
		1e. 🗌	Explanations of Relevancy of References (ATTACHMENT 1(e), hereto) for providing a concise explanation of non-English publications.
		1f. 🔲	List of Copending Applications (ATTACHMENT 1(f), hereto).
		1g. 🔯	List of Additional Submitted Documents (ATTACHMENT 1(g), hereto).
2.	$\boxtimes$	This Infor	mation Disclosure Statement is filed under 37 CFR § 1.97(b):
		•	(Check either Item 2a or 2b or 2c or 2d)
		2a. 🗌	Within three months of the filing date of a national application;
		2b. 🗌	Within three months of the date of entry of the national stage as set forth in § 1.491 in an international application.
		2c. 🛛	Before the mailing of a first Office Action on the merits; or
		2d. 🗌	Before the mailing of a first Office Action after the filing of a Request for Continued Examination under § 1.114.

4)

Serial No.: 10/706,912

3.	specified Action un	rmation Disclosure Statement is filed under 37 CFR § 1.97(c) after the period in paragraph 2 above but before the mailing date of any of a Final Office ider § 1.113, a Notice of Allowance under § 1.311 or an action that otherwise osecution in the application, AND
		(Check either Item 3a or 3b; Item 3b to be checked if any reference known for more than 3 months)
	3a.	The § 1.97(e) Statement in Item 5 below is applicable; OR The \$180.00 fee set forth in 37 CFR § 1.17(p) is:  enclosed.
		to be charged to Deposit Account No. 19-3935.
4.		rmation Disclosure Statement is filed under 37 CFR § 1.97(d) after the period in paragraph 3 above, but on or before payment of the Issue Fee, AND
	4a. ☐ 4b. ☐	The § 1.97(e) Statement in Item 5 below is applicable; AND The \$180.00 fee set forth in 37 CFR § 1.17(p) is:  enclosed.
		to be charged to Deposit Account No. 19-3935.
5.	Statemen	nt under § 1.97(e) (applicable if Item 3a or Item 4a is checked) (Check either Item 5a or 5b)
	5a. 🗌	In accordance with 37 CFR § 1.97(e)(1), it is stated that each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.
	5b. 📋	In accordance with 37 CFR § 1.97(e)(2), it is stated that no item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in this Information Disclosure Statement was known by any individual designated in § 1.56(c) more than three months prior to the filing of this Information Disclosure Statement.
6.	This is a (1.53(b).	continuation/divisional/continuation-in-part application under 37 CFR §
		(Check appropriate Items 6a and/or 6b)
	6a. 🗌	Copies of the publications listed on the attached Form PTO-1449 which were previously cited in prior application Serial No, filed on, and which is relied on for an earlier effective filing date for the subject application under 35 U.S.C. § 120, have been omitted pursuant to 37 CFR § 1.98(d).
	6b. 🗌	Copies of the publications listed on the attached Form PTO-1449 which were not previously cited in prior application Serial No, filed on, and which is relied on for an earlier effective filing date for the subject application under 35 U.S.C. § 120, are provided herewith.

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7.		This	is a f	Request for Continued Examination under 37 CFR § 1.114.
		7a. 7b.		(Check either Item 7a or 7b)  The Issue Fee has not been paid.  A Petition to Withdraw from issue under 37 CFR § 1.313(c) is filed concurrently herewith or has been granted. A Request for Continued Examination under 37 CFR § 1.114, after payment of the Issue Fee, is proper in accordance with 37 CFR § 1.114(a), respectively.
8.		This	is a S	Supplemental Information Disclosure Statement. (Check either Item 8a or 8b)
		8a.		This Supplemental Information Disclosure Statement under 37 CFR § 1.97(f) supplements the Information Disclosure Statement filed on A bona fide attempt was made to comply with 37 CFR § 1.98, but inadvertent omissions were made. These omissions have been corrected herein. Accordingly, additional time is requested so that this Supplemental IDS can
		8b.		be considered as if properly filed on  This Supplemental Information Disclosure Statement is timely filed within one (1) month of the Notice under 37 CFR §§ 1.97 and 1.98, mailed
9.				to be the relevance of each non-English language publication is:
		_	_	(Check appropriate Items 9a, 9b, 9c and/or 9d)
		9a.		satisfied for the non-English language publication(s) cited on the enclosed "English language version of the search report or action which indicates the degree of relevance found by the foreign office". (See MPEP § 609, Minimum Requirements for an Information Disclosure Statement, Part A(3): Concise Explanation of Relevance, 8th Ed., Rev. 2)
		9b. 9c.	_	set forth in the application. satisfied for the non-English language publication(s) indicated on the attached Form PTO-1449 as having an English language translation
		9d.		(complete or relevant portion(s)) attached thereto. enclosed as Attachment 1(e), hereto.
10.	be se	e, mat earch	erial repor	n is made that the information cited in this Statement is, or is considered to to patentability nor a representation that a search has been made (other than t(s) from a counterpart foreign application or a PCT International Search omitted herewith). 37 CFR §§ 1.97(g) and (h).

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11. The Commissioner is authorized to credit any overpayment or charge any additional fee required under 37 CFR § 1.17 for this Information Disclosure Statement to Deposit Account No. 19-3935.

Respectfully submitted,

STAAS & HALSEY LLP

Dated: Oth, 10, 200 1201 New York Ave., N.W., 7th Floor

Washington, D.C. 20005 Telephone: (202) 434-1500 Facsimile: (202) 434-1501 By:

Registration No. 22,010

Sheet <u>1</u> of <u>1</u> APPLICATION NO ATTORNEY DOCKET NO. FORM PTO-1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE 300.1138 10/706.912 FIRST NAMED INVENTOR FORMATION DISCLOSURE STATEMENT Mitsutoshi HIGASHI FILING DATE **GROUP ART UNIT** (Use several sheets if necessary) November 14, 2003 2813 **U.S. PATENT DOCUMENTS** DOCUMENT SUB-**FILING** NO. DATE NAME **CLASS** CLASS DATE AA 5,895,233 04/20/99 HIGASHI et al. AB 6,316,840 11/13/01 OTANI AC 5,610,431 03/11/97 **MARTIN** AD 6,214,644 04/10/01 **GLENN** AΕ 05/07/02 6,384,473 PETERSON et al. AF 6,140,144 10/31/00 NAJAFI et al. FOREIGN PATENT DOCUMENTS DOCUMENT **ABSTRACT** NO. DATE COUNTRY TRANSLATION YES NO AG 02/01633 01/03/02 **WIPO** AΗ 99/67818 12/29/99 **WIPO** 02/055431 **WIPO** ΑI 07/18/02 OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.) TRANSLATION YES NO G. A. Riley et al., "Stud Bump Flip Chip Assembly of MEMS and ΑJ MOEMS," Proceedings of the SPIE, International Symposium on Microelectronics, vol. 4587, Oct. 2001, pp. 662-665. K. Jongbaeg et al., "Ultrasonic Bonding of In/Au and Aval for Hermetic Sealing of MEMS Packaging," IEEE International Micro Electro ΑK Mechanical Systems Conference, Proceedings of the IEEE, January 2002, pp. 415-418. M. Heschel, "Stacking Technology for a Space Constrained Microsystem," AL Micro Electro Mechanical Systems, 1998, MEMS 98, Proceedings, IEEE, January 1998, pp. 312-317. H. Park et al., "Packaging of the RF-MEMS Switch," Design, Characterization and Packaging for MEMS and Microelectronics II. AM Proceedings of the SPIE, vol. 4593, December 2001, pp. 234-243. **EXAMINER** DATE CONSIDERED \*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through

citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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# OF ADDITIONAL SUBMITTED DOCUMENTS

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ATTORNEY DOCKET NO.	APPLICATION NO.
300.1138	10/706,912
FIRST NAMED INVENTOR	
Mitsutoshi HIGASHI	
FILING DATE	GROUP ART UNIT
November 14, 2003	2813

The following document(s) is/are listed in accordance with the duty of disclosure provisions of 37 CFR § 1.56, so that the Examiner may consider same should he deem any thereof to be material to examination of the subject application.

It is requested that the Examiner acknowledge his consideration of document(s) below-listed by initialling same in the space provided adjacent each such application and that the Examiner sign and date this form at the bottom thereof to confirm such consideration having been given.

This submission in no way represents an admission that any of the information listed herein constitutes prior art with respect to the subject application; and unless and until such prior art status is established, this submission is not a request that the information presented herein be printed on the face of any patent issuing from the subject application in which this information is being filed.

#### **U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL		DOCUMENT NO.	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	AA						
	AB						

### FOREIGN PATENT DOCUMENTS

	DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSI YES	ATION NO
AC							÷

OTHER DO	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)			
	AD	European Search Report and Annex of Application No. EP 03 25 7126 dated July 20, 2005.		
	AE	Partial European Search Report and Annex of Application No. EP 03 25 7126 dated May 9, 2005.		

EXAMINER	DATE CONSIDERED
*EXAMINER: Initial if document consider	ed, whether or not citation is in conformance with MPEP 609; Draw line through

citation if not in conformance and not considered. Include copy of this form with next communication to applicant.